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## **5-Channel Precision Temperature Monitor**

### **General Description**

The MAX6699 precision multichannel temperature sensor monitors its own temperature and the temperatures of up to four external diode-connected transistors. All temperature channels have programmable alert thresholds. Channels 1 and 4 also have programmable overtemperature thresholds. When the measured temperature of a channel exceeds the respective threshold, a status bit is set in one of the status registers. Two open-drain outputs, OVERT and ALERT, assert corresponding to these bits in the status register.

The 2-wire serial interface supports the standard system management bus (SMBus<sup>™</sup>) protocols: write byte, read byte, send byte, and receive byte for reading the temperature data and programming the alarm thresholds.

The MAX6699 is specified for an operating temperature range of -40°C to +125°C and is available in 16-pin QSOP and 16-pin TSSOP packages.

**Applications** 

Desktop Computers Notebook Computers Workstations Servers

SMBus is a trademark of Intel Corp.

### **Features**

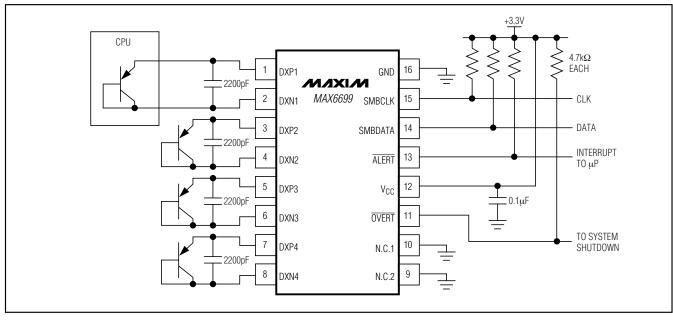
- Four Thermal-Diode Inputs
- Local Temperature Sensor
- 1°C Remote Temperature Accuracy (+60°C to +100°C)
- Temperature Monitoring Begins at POR for Fail-Safe System Protection
- ALERT and OVERT Outputs for Interrupts, Throttling, and Shutdown
- Small 16-Pin QSOP and 16-Pin TSSOP Packages
- ♦ 2-Wire SMBus Interface

### **Ordering Information**

PART	TEMP RANGE	PIN- PACKAGE	PKG CODE
MAX6699EE	-40°C to +125°C	16 QSOP	E16-1
MAX6699UE	-40°C to +125°C	16 TSSOP	U16-1

See the Slave Address section.

#### Pin Configuration appears at end of data sheet.



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For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

## **Typical Application Circuit**

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### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{CC} = +3.0V \text{ to } +5.5V, T_A = -40^{\circ}\text{C} \text{ to } +125^{\circ}\text{C}, \text{ unless otherwise noted}. Typical values are at V_{CC} = +3.3V \text{ and } T_A = +25^{\circ}\text{C}.)$  (Note 1)

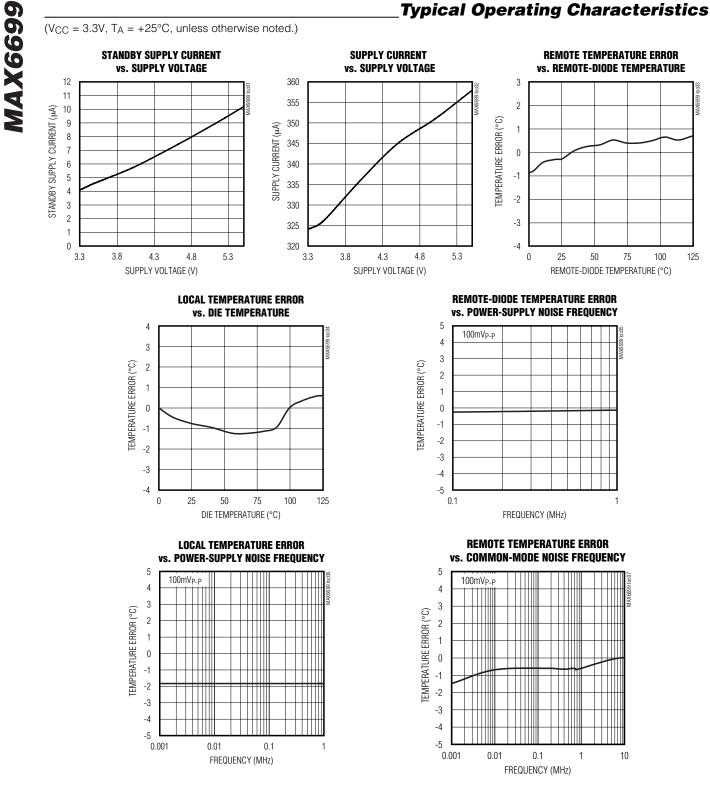
PARAMETER	SYMBOL	CONDITIONS	MIN	ТҮР	MAX	UNITS	
SMBus INTERFACE (SCL, SDA)							
Logic Input Low Voltage	VIL				0.8	V	
	Maria	$V_{CC} = 3.0V$	2.2			V	
Logic Input High Voltage	VIH	$V_{CC} = 5.0V$	2.4			V	
Input Leakage Current			-1		+1	μA	
Output Low Voltage	Vol	I <sub>SINK</sub> = 6mA			0.3	V	
Input Capacitance	CIN			5		рF	
SMBus-COMPATIBLE TIMING (Fi	gures 3 and	4) (Note 2)	•			·	
Serial Clock Frequency	fscl	(Note 3)			400	kHz	
Bus Free Time Between STOP		f <sub>SCL</sub> = 100kHz	4.7				
and START Condition	tBUF	f <sub>SCL</sub> = 400kHz	1.6			μs	
		f <sub>SCL</sub> = 100kHz	4.7	,		μs	
START Condition Setup Time		f <sub>SCL</sub> = 400kHz	0.6				
Repeat START Condition Setup Time		90% of SCL to 90% of SDA, f <sub>SCL</sub> = 100kHz	0.6			μs	
	<sup>t</sup> su:sta	90% of SCL to 90% of SDA, f <sub>SCL</sub> = 400kHz	0.6				
START Condition Hold Time	thd:sta	10% of SDA to 90% of SCL	0.6			μs	
	tsu:sto	90% of SCL to 90% of SDA, $f_{SCL} = 100 kHz$	4				
STOP Condition Setup Time		90% of SCL to 90% of SDA, $f_{SCL} = 400 \text{kHz}$	0.6			μs	
Clock Low Period	tLOW	10% to 10%, $f_{SCL} = 100 \text{kHz}$	1.3			μs	
Cleak Lligh Dariad		10% to 10%, f <sub>SCL</sub> = 400kHz 90% to 90%	1.3 0.6				
Clock High Period	thigh					μs	
Data Hold Time	thd:dat	$f_{SCL} = 100 \text{kHz}$	300		000	ns	
		$f_{SCL} = 400 \text{kHz} (\text{Note 4})$	050		900	-	
Data Setup Time	tsu:dat	$f_{SCL} = 100 \text{kHz}$	250			ns	
		$f_{SCL} = 400 \text{kHz}$	100				
Receive SCL/DSA Rise Time	t <sub>R</sub>	$f_{SCL} = 100 \text{kHz}$			1	μs	
	1	$f_{SCL} = 400 \text{kHz}$			0.3	<u> </u>	
Receive SCL/SDA Fall Time	tF				300	ns	
Pulse Width of Spike Suppressed	tsp		0		50	ns	
SMBus Timeout	<sup>t</sup> TIMEOUT	SDA low period for interface reset	25	37	45	ms	

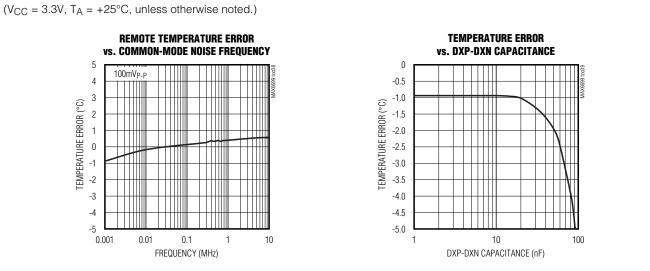
Note 1: All parameters are tested at  $T_A = +25^{\circ}C$ . Specifications over temperature are guaranteed by design.

**Note 2:** Timing specifications are guaranteed by design.

Note 3: The serial interface resets when SCL is low for more than t<sub>TIMEOUT</sub>.

Note 4: A transition must internally provide at least a hold time to bridge the undefined region (300ns max) of SCL's falling edge.





### Typical Operating Characteristics (continued)

## **Pin Description**

PIN	NAME	FUNCTION
1	DXP1	Combined Current Source and A/D Positive Input for Channel 1 Remote Diode. Connect to the anode of a remote-diode-connected temperature-sensing transistor. Leave floating or connect to DXN1 if no remote diode is used. Place a 2200pF capacitor between DXP1 and DXN1 for noise filtering.
2	DXN1	Cathode Input for Channel 1 Remote Diode. Connect the cathode of the channel 1 remote-diode- connected transistor to DXN1.
3	DXP2	Combined Current Source and A/D Positive Input for Channel 2 Remote Diode. Connect to the anode of a remote-diode-connected temperature-sensing transistor. Leave floating or connect to DXN2 if no remote diode is used. Place a 2200pF capacitor between DXP2 and DXN2 for noise filtering.
4	DXN2	Cathode Input for Channel 2 Remote Diode. Connect the cathode of the channel 2 remote-diode- connected transistor to DXN2.
5	DXP3	Combined Current Source and A/D Positive Input for Channel 3 Remote Diode. Connect to the anode of a remote-diode-connected temperature-sensing transistor. Leave floating or connect to DXN3 if no remote diode is used. Place a 2200pF capacitor between DXP3 and DXN3 for noise filtering.
6	DXN3	Cathode Input for Channel 3 Remote Diode. Connect the cathode of the channel 1 remote-diode- connected transistor to DXN3.

### **Pin Description (continued)**

PIN	NAME	FUNCTION
7	DXP4	Combined Current Source and A/D Positive Input for Channel 4 Remote Diode. Connect to the anode of a remote-diode-connected temperature-sensing transistor. Leave floating or connect to DXN4 if no remote diode is used. Place a 2200pF capacitor between DXP4 and DXN4 for noise filtering.
8	DXN4	Cathode Input for Channel 4 Remote Diode. Connect the cathode of the channel 1 remote-diode- connected transistor to DXN4.
9, 10	N.C	No Connection. Must be connected to ground.
11	OVERT	Overtemperature Active-Low, Open-Drain Output. OVERT asserts low when the temperature of channels 1 and 4 exceeds the programmed threshold limit.
12	V <sub>CC</sub>	Supply Voltage Input. Bypass to GND with a 0.1µF capacitor.
13	ALERT	SMBus Alert (Interrupt), Active-Low, Open-Drain Output. ALERT asserts low when the temperature of any channel exceeds the programmed ALERT threshold.
14	SMBDATA	SMBus Serial-Data Input/Output. Connect to a pullup resistor.
15	SMBCLK	SMBus Serial-Clock Input. Connect to a pullup resistor.
16	GND	Ground

### **Detailed Description**

The MAX6699 is a precision multichannel temperature monitor that features one local and four remote temperature-sensing channels with a programmable alert threshold for each temperature channel and a programmable overtemperature threshold for channels 1 and 4 (see Figure 1). Communication with the MAX6699 is achieved through the SMBus serial interface and a dedicated alert pin. The alarm outputs, OVERT and ALERT, assert if the software-programmed temperature thresholds are exceeded. ALERT typically serves as an interrupt, while OVERT can be connected to a fan, system shutdown, or other thermal-management circuitry.

#### **ADC Conversion Sequence**

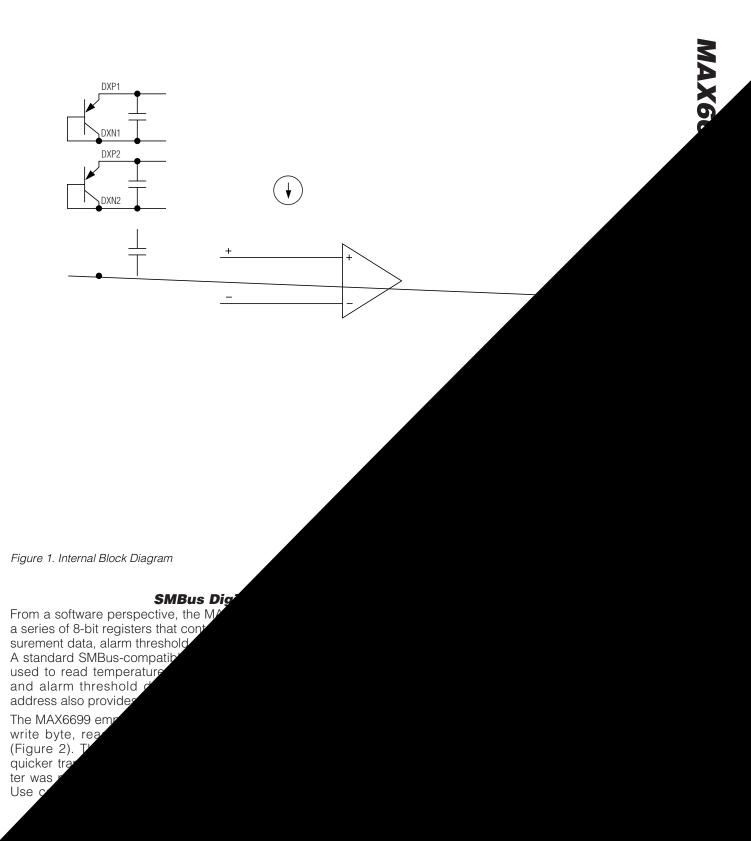
In the default conversion mode, the MAX6699 starts the conversion sequence by measuring the temperature on channel 1, followed by 2, 3, and local channel 4. The conversion result for each active channel is stored in the corresponding temperature data register.

In some systems, one of the remote thermal diodes may be monitoring a location that experiences temperature changes that occur much more rapidly than in the other channels. If faster temperature changes must be monitored in one of the temperature channels, the MAX6699 allows channel 1 to be monitored at a faster rate than the other channels. In this mode (set by writing a 1 to bit 4 of the configuration 1 register), measurements of channel 1 alternate with measurements of the other channels. The sequence becomes channel 1, channel 2, channel 1, channel 3, channel 1, etc. Note that the time required to measure all five channels is considerably greater in this mode than in the default mode.

#### Low-Power Standby Mode

Standby mode reduces the supply current to less than  $15\mu$ A by disabling the internal ADC. Enter standby by setting the STOP bit to 1 in the configuration 1 register. During standby, data is retained in memory, and the SMBus interface is active and listening for SMBus commands. The timeout is enabled if a start condition is recognized on SMBus. Activity on the SMBus causes the supply current to increase. If a standby command is received while a conversion is in progress, the conversion cycle is interrupted, and the temperature registers are not updated. The previous data is not changed and remains available.

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5	S ADDRESS WR			ACK		COM	MAND		ACK		ΑΤΑ		ACK		Ρ
	7 bi	ts				8 k	oits			8	bits				1
Read	Slave A lent to c a 3-wire d Byte Form	hip-sele interface	ct line o				d Byte: ster you		lects to writing	set k thres	oy the	e com , confi	goes into t imand by guration n	rte (to s	set
s	ADDRESS	WR	AC		ID 4	АСК	S	A	DDRESS	RD	A	СК	DATA	///	Р
	7 bits			8 bits					7 bits				8 bits		
		dress: equiva- p-select line command Byte: sele from which register y are reading													
Sen	d Byte Form	at					Re	ceiv	ve Byte F	orma	t				
S	ADDRESS	WR	ACK	COMMAND	ACK	Р		S	ADDRES	S F	D	АСК	DATA	///	Ρ
	7 bits			8 bits					7 bits				8 bits		
	Start condition Stop condition		r u ded = S	Command Byte nand with no Ised for one-st lave transmiss cnowledged	data, not con	usually	/					ti b v a	Data Byte: he registe by the las write byte also used esponse re	er comn t read transm for SMB	hande byte hissio us ale

Figure 2. SMBus Protocols

# Table 1. Main Temperature Register(High Byte) Data Format

TEMP (°C)	DIGITAL OUTPUT
>127	0111 1111
127	0111 1111
126	0111 1110
25	0001 1001
0.00	0000 0000
<0.00	0000 0000
Diode fault (short or open)	1111 1111

conversion results until they have been read. If the most significant bits have not been read within an SMBus timeout period (nominally 37ms), normal updating continues. Table 1 shows the main temperature register (high byte) data format, and Table 2 shows the extended resolution register (low byte) data format.

# Table 2. Extended Resolution TemperatureRegister (Low Byte) Data Format

TEMP (°C)	DIGITAL OUTPUT
0	000X XXXX
+0.125	001X XXXX
+0.250	010X XXXX
+0.375	011X XXXX
+0.500	100X XXXX
+0.625	101X XXXX
+0.725	110X XXXX
+0.875	111X XXXX

#### **Diode Fault Detection**

If a channel's input DXP\_ and DXN\_ are left open or shorted together, the MAX6699 detects a diode fault. A diode fault, whether a short or an open circuit, does not cause either ALERT or OVERT to assert. A bit in the status register for the corresponding channel is set to 1, and the temperature data for the channel is stored as all 1s. It takes approximately 4ms for the MAX6699 to detect a diode fault. Once a diode fault is detected, the MAX6699 jumps onto the next channel in the conversion sequence.



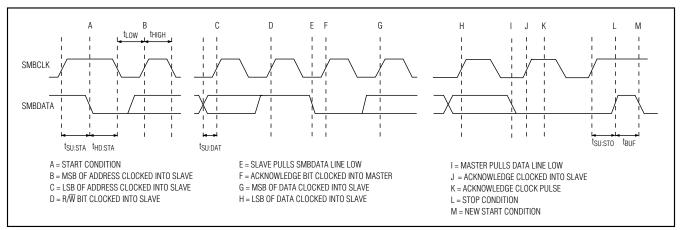


Figure 3. SMBus Write Timing Diagram

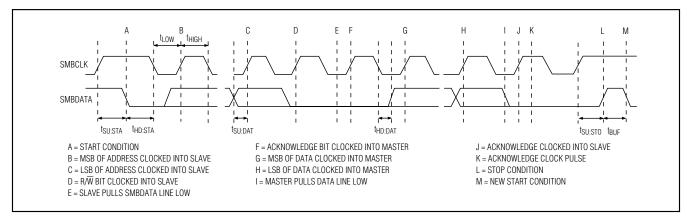


Figure 4. SMBus Read Timing Diagram

#### **Alarm Threshold Registers**

There are 9 alarm threshold registers that store overtemperature ALERT and OVERT threshold values. Seven of these registers are dedicated to store one local alert temperature threshold limit and six remote alert temperature threshold limits (see the ALERT Interrupt Mode section). The remaining two registers are dedicated to remote channels 1 and 4 to store overtemperature threshold limits (see the OVERT Overtemperature Alarm section). Access to these registers is provided through the SMBus interface.

#### **ALERT** Interrupt Mode

An ALERT interrupt occurs when the internal or external temperature reading exceeds a high-temperature limit

(user programmable). The ALERT output clears if the temperature goes below the high-temperature limit threshold. The ALERT interrupt output signal can also be cleared by reading the status register(s) associated with the fault(s) or by successfully responding to an alert response address transmission by the master. In both cases, the alert is cleared, but is reasserted at the end of the next conversion if the fault condition still exists. The interrupt does not halt automatic conversions. The ALERT output is open drain so that multiple devices can share a common interrupt line. All ALERT interrupts can be masked using the configuration 3 register. The POR state of these registers is shown in Table 3.

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REGISTER	ADDRESS (HEX)	POR STATE (HEX)	READ/ WRITE	DESCRIPTION
Local	07	00	R	Read local temperature register
Remote 1	01	00	R	Read channel 1 remote temperature register
Remote 2	02	00	R	Read channel 2 remote temperature register
Remote 3	03	00	R	Read channel 3 remote temperature register
Remote 4	04	00	R	Read channel 4 remote temperature register
Reserved	05	00	R	—
Reserved	06	00	R	—
Configuration 1	41	00	R/W	Read/write configuration register 1
Configuration 2	42	00	R/W	Read/write configuration register 2
Configuration 3	43	00	R/W	Read/write configuration register 3
Status1	44	00	R	Read status register 1
Status2	45	00	R	Read status register 2
Status3	46	00	R	Read status register 3
Local ALERT High Limit	17	5A	R/W	Read/write local alert high-temperature threshold limit register
Remote 1 ALERT High Limit	11	6E	R/W	Read/write channel 1 remote-diode alert high-temperature threshold limit register
Remote 2 ALERT High Limit	12	7F	R/W	Read/write channel 2 remote-diode alert high-temperature threshold limit register
Remote 3 ALERT High Limit	13	64	R/W	Read/write channel 3 remote-diode alert high-temperature threshold limit register
Remote 4 ALERT High Limit	14	64	R/W	Read/write channel 4 remote-diode alert high-temperature threshold limit register
Reserved	15	64	R/W	_
Reserved	16	64	R/W	_
Remote 1 OVERT High Limit	21	6E	R/W	Read/write channel 1 remote-diode overtemperature threshold limit register
Remote 4 OVERT High Limit	24	7F	R/W	Read/write channel 4 remote-diode overtemperature threshold limit register
Reserved	25	5A	R/W	_
Reserved	26	5A	R/W	_
Remote 1 Extended Temperature	09	00	R	Read channel 1 remote-diode extended temperature register
Manufacturer ID	0A	4D	R	Read manufacturer ID

## Table 3. Command Byte Register Bit Assignment

M/IXI/M

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#### **ALERT** Response Address

The SMBus alert response interrupt pointer provides quick fault identification for simple slave devices that lack the complex logic needed to be a bus master. Upon receiving an interrupt signal, the host master can broadcast a receive byte transmission to the alert response slave address (see the *Slave Addresses* section). Then, any slave device that generated an interrupt attempts to identify itself by putting its own address on the bus.

The alert response can activate several different slave devices simultaneously, similar to the I<sup>2</sup>C\* General Call. If more than one slave attempts to respond, bus arbitration rules apply, and the device with the lower address code wins. The losing device does not generate an acknowledgment and continues to hold the ALERT line low until cleared. (The conditions for clearing an alert vary depending on the type of slave device.) Successful completion of the alert response protocol clears the output latch. If the condition that caused the alert still exists, the MAX6699 reasserts the ALERT interrupt at the end of the next conversion.

### **OVERT** Overtemperature Alarms

The MAX6699 has two overtemperature registers that store remote alarm threshold data for the OVERT output. OVERT is asserted when a channel's measured temperature is greater than the value stored in the corresponding threshold register. OVERT remains asserted until the temperature drops below the programmed threshold minus 4°C hysteresis. An overtemperature output can be used to activate a cooling fan, send a warning, initiate clock throttling, or trigger a system shutdown to prevent component damage. See Table 3 for the POR state of the overtemperature threshold registers.

#### **Command Byte Functions**

The 8-bit Command Byte register (Table 3) is the master index that points to the various other registers within the MAX6699. This register's POR state is 0000 0000.

#### **Configuration Bytes Functions**

There are three Read-Write Configuration registers (Tables 4, 5, and 6) that can be used to control the MAX6699's operation.

<sup>\*</sup>Purchase of I<sup>2</sup>C components from Maxim Integrated Products, Inc., or one of its sublicensed Associated Companies, conveys a license under the Philips I<sup>2</sup>C Patent Rights to use these components in an I<sup>2</sup>C system, provided that the system conforms to the I<sup>2</sup>C Standard Specification as defined by Philips.



#### **Configuration 1 Register**

The Configuration 1 register (Table 4) has several functions. Bit 7(MSB) is used to put the MAX6699 either in software standby mode (STOP) or continuous conversion mode. Bit 6 resets all registers to their power-on reset conditions and then clears itself. Bit 5 disables the SMBus timeout. Bit 4 enables more frequent conversions on channel 1, as described in the *ADC Conversion Sequence* section. Bit 3 enables resistance cancellation on channel 1. See the *Series Resistance Cancellation* section for more details. The remaining bits of the Configuration 1 register are not used. The POR state of this register is 0000 0000 (00h).

#### **Configuration 2 Register**

The Configuration 2 register functions are described in Table 5. Bits [6:0] are used to mask the ALERT interrupt output. Bit 6 masks the local alert interrupt and bit 5 through bit 2 mask the remote alert interrupts. The power-up state of this register is 0000 0000 (00h).

#### **Configuration 3 Register**

Table 6 describes the Configuration 3 register. Bits 3 and 0 mask the OVERT interrupt output for channels 4 and 1. The remaining bits, 7, 6, 5, 4, 2, and 1, are reserved. The power-up state of this register is 0000 0000 (00h).

#### **Status Registers Functions**

Status registers 1, 2, and 3 (Tables 7, 8, and 9) indicate which (if any) temperature thresholds have been exceeded and if there is an open-circuit or short-circuit fault detected with the external sense junctions. Status register 1 indicates if the measured temperature has exceeded the threshold limit set in the ALERT registers for the local or remote-sensing diodes. Status register 2 indicates if the measured temperature has exceeded the threshold limit set in the OVERT registers. Status register 3 indicates if there is a diode fault (open or short) in any of the remote-sensing channels.

Bits in the Alert Status register clear by a successful read, but set again after the next conversion unless the fault is corrected, either by a drop in the measured temperature or an increase in the threshold temperature.

The ALERT interrupt output follows the status flag bit. Once the ALERT output is asserted, it can be deasserted by either reading Status register 1 or by successfully responding to an alert response address. In both

BIT	NAME	POR STATE	FUNCTION
7(MSB)	STOP	0	Standby Mode Control Bit. If STOP is set to logic 1, the MAX6699 stops converting and enters standby mode.
6	POR	0	Reset Bit. Set to logic 1 to put the device into its power-on state. This bit is self- clearing.
5	TIMEOUT	0	Timeout Enable Bit. Set to logic 0 to enable SMBus timeout.
4	Fast remote 1	0	Channel 1 Fast Conversion Bit. Set to logic 1 to enable fast conversion of channel 1.
3	Resistance cancellation	0	Resistance Cancellation Bit. When set to logic 1, the MAX6699 cancels series resistance in the channel 1 thermal diode.
2	Reserved	0	—
1	Reserved	0	_
0	Reserved	0	—

### Table 4. Configuration 1 Register

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### Table 5. Configuration 2 Register

BIT	NAME	POR STATE	FUNCTION
7(MSB)	Reserved	0	
6	Mask Local ALERT	0	Local Alert Mask. Set to logic 1 to mask local channel ALERT.
5	Reserved	0	_
4	Reserved	0	—
3	Mask ALERT 4	0	Channel 4 Alert Mask. Set to logic 1 to mask channel 4 ALERT.
2	Mask ALERT 3	0	Channel 3 Alert Interrupt Mask. Set to logic 1 to mask channel 3 ALERT.
1	Mask ALERT 2	0	Channel 2 Alert Mask. Set to logic 1 to mask channel 2 ALERT.
0	Mask ALERT 1	0	Channel 1 Alert Mask. Set to logic 1 to mask channel 1 ALERT.

cases, the alert is cleared even if the fault condition exists, but the ALERT output reasserts at the end of the <u>next</u> conversion. The bits indicating the fault for the OVERT interrupt output clear only on reading the Status 2 register even if the fault conditions still exist. Reading the Status 2 register does not clear the OVERT interrupt output. To eliminate the fault condition, either the measured temperature must drop below the temperature threshold minus the hysteresis value (4°C), or the trip temperature.

### **Applications Information**

#### **Remote-Diode Selection**

The MAX6699 directly measures the die temperature of CPUs and other ICs that have on-chip temperature-

sensing diodes (see the *Typical Application Circuit*), or it can measure the temperature of a discrete diode-connected transistor.

#### **Effect of Ideality Factor**

The accuracy of the remote temperature measurements depends on the ideality factor (n) of the remote diode (actually a transistor). The MAX6699 is optimized for n = 1.008. A thermal diode on the substrate of an IC is normally a pnp with the base and emitter brought out the collector (diode connection) grounded. DXP\_ must be connected to the anode (emitter), and DXN\_ must be connected to the cathode (base) of this pnp. If a sense transistor with an ideality factor other than 1.008 is used, the output data is different from the data obtained with the optimum ideality factor. Fortunately, the difference is predictable. Assume a remote-diode



ВІТ	NAME	POR STATE	FUNCTION
7(MSB)	Reserved	0	—
6	Reserved	0	—
5	Reserved	_	—
4	Reserved	_	—
3	Mask OVERT 4	0	Channel 4 Remote-Diode OVERT Mask Bit. Set to logic 1 to mask channel 4 OVERT.
2	Reserved	0	—
1	Reserved	0	—
0	Mask OVERT 1	0	Channel 1 Remote-Diode OVERT Mask Bit. Set to logic 1 to mask channel 1 OVERT.

Table 6. Configuration 3 Register

sensor designed for a nominal ideality factor  $n_{NOMINAL}$  is used to measure the temperature of a diode with a different ideality factor n1. The measured temperature  $T_M$  can be corrected using:

$$T_{M} = T_{ACTUAL} \left( \frac{n_{1}}{n_{NOMINAL}} \right)$$

where temperature is measured in Kelvin and  $n_{NOMIMAL}$  for the MAX6699 is 1.008. As an example, assume you want to use the MAX6699 with a CPU that has an ideality factor of 1.002. If the diode has no series resistance, the measured data is related to the real temperature as follows:

$$T_{ACTUAL} = T_{M} \times \left(\frac{n_{NOMINAL}}{n_{1}}\right) = T_{M} \times \left(\frac{1.008}{1.002}\right) = T_{M}(1.00599)$$

For a real temperature of  $+85^{\circ}C$  (358.15K), the measured temperature is  $+82.87^{\circ}C$  (356.02K), an error of  $-2.13^{\circ}C$ .

#### **Series Resistance Cancellation**

Some thermal diodes on high-power ICs can have excessive series resistance, which can cause temperature-measurement errors with conventional remote temperature sensors. Channel 1 of the MAX6699 has a series resistance cancellation feature (enabled by bit 3 of the Configuration 1 register) that eliminates the effect of diode series resistance. Set bit 3 to 1 if the series resistance is large enough to affect the accuracy of channel 1. The series resistance cancellation function increases the conversion time for channel 1 by 125ms. This feature cancels the bulk resistance of the sensor and any other resistance in series (wire, contact resistance, etc.). The cancellation range is from 0 to  $100\Omega$ .

#### **Discrete Remote Diodes**

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When the remote-sensing diode is a discrete transistor. its collector and base must be connected together. Table 10 lists examples of discrete transistors that are appropriate for use with the MAX6699. The transistor must be a small-signal type with a relatively high forward voltage; otherwise, the A/D input voltage range can be violated. The forward voltage at the highest expected temperature must be greater than 0.25V at 10µA, and at the lowest expected temperature, the forward voltage must be less than 0.95V at 100µA. Large power transistors must not be used. Also, ensure that the base resistance is less than  $100\Omega$ . Tight specifications for forward current gain (50 <  $\beta$  <150, for example) indicate that the manufacturer has good process controls and that the devices have consistent VBE characteristics. Manufacturers of discrete transistors do not normally specify or guarantee ideality factor. This is normally not a problem since good-quality discrete transistors tend to have ideality factors that fall within a relatively narrow range. A variety of discrete transistors have variations in remote temperature readings of less than ±2°C. Still, it is good design practice to verify good consistency of temperature readings with several discrete transistors from any manufacturer under consideration.

BIT	NAME	POR STATE	FUNCTION
7(MSB)	Reserved	0	—
6	Local ALERT	0	Local Channel High-Alert Bit. This bit is set to logic 1 when the local temperature exceeds the temperature threshold limit in the local ALERT high-limit register.
5	Reserved	_	—
4	Reserved	_	—
3	Remote 4 ALERT	0	Channel 4 Remote-Diode High-Alert Bit. This bit is set to logic 1 when the channel 4 remote-diode temperature exceeds the temperature threshold limit in the remote 4 ALERT high-limit register.
2	Remote 3 ALERT	0	Channel 3 Remote-Diode High-Alert Bit. This bit is set to logic 1 when the channel 3 remote-diode temperature exceeds the programmed temperature threshold limit in the remote 3 ALERT high-limit register.
1	Remote 2 ALERT	0	Channel 2 Remote-Diode High-Alert Bit. This bit is set to logic 1 when the channel 2 remote-diode temperature exceeds the temperature threshold limit in the remote 2 ALERT high-limit register.
0	Remote 1 ALERT	0	Channel 1 Remote-Diode High-Alert Bit. This bit is set to logic 1 when the channel 1 remote-diode temperature exceeds the temperature threshold limit in the remote 1 ALERT high-limit register.

#### Table 7. Status 1 Register

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#### **Unused Diode Channels**

If one or more of the remote-diode channels is not needed, short the DXP and DXN pins for that channel together. The status register indicates a diode fault for this channel and the channel is ignored during the temperature-measurement sequence.

#### **Thermal Mass and Self-Heating**

When sensing local temperature, the MAX6699 measures the temperature of the PC board to which it is soldered. The leads provide a good thermal path between the PC board traces and the die. As with all IC temperature sensors, thermal conductivity between the die and the ambient air is poor by comparison, making air temperature measurements impractical. Because the thermal mass of the PC board is far greater than that of the MAX6699, the device follows temperature changes on the PC board with little or no perceivable delay. When measuring the temperature of a CPU or other IC with an on-chip sense junction, thermal mass has virtually no effect; the measured temperature of the junction tracks the actual temperature within a conversion cycle.

When measuring temperature with discrete remote transistors, the best thermal response times are obtained with transistors in small packages (i.e., SOT23 or SC70). Take care to account for thermal gradients between the heat source and the sensor, and ensure that stray air currents across the sensor package do not interfere with measurement accuracy. Self-heating does not significantly affect measurement accuracy. Remote-sensor self-heating due to the diode current source is negligible.

### Table 8. Status 2 Register

BIT	NAME	POR STATE	FUNCTION
7(MSB)	Reserved	0	_
6	Reserved	0	—
5	Reserved	_	—
4	Reserved	—	—
3	Remote 4 OVERT	0	Channel 4 Remote Diode Overtemperature Status Bit. This bit is set to logic 1 when the channel 4 remote-diode temperature exceeds the temperature threshold limit in the remote 4 OVERT high-limit register.
2	Reserved	0	—
1	Reserved	0	—
0	Remote 1 OVERT	0	Channel 1 Remote-Diode Overtemperature Status Bit. This bit is set to logic 1 when the channel 1 remote-diode temperature exceeds the temperature threshold limit in the remote 1 OVERT high-limit register.

## Table 9. Status 3 Register

BIT	NAME	POR STATE	FUNCTION
7(MSB)	Reserved	0	—
6	Reserved	0	Not Used. 0 at POR, then 1.
5	Reserved	0	Not Used. 0 at POR, then 1.
4	Diode fault 4	0	Channel 4 Remote-Diode Fault Bit. This bit is set to 1 when DXP4 and DXN4 are either shorted or open circuit.
3	Diode fault 3	0	Channel 3 Remote-Diode Fault Bit. This bit is set to 1 when DXP3 and DXN3 are either shorted or open circuit.
2	Diode fault 2	0	Channel 2 Remote-Diode Fault Bit. This bit is set to 1 when DXP2 and DXN2 are either shorted or open circuit.
1	Diode fault 1	0	Channel 1 Remote-Diode Fault Bit. This bit is set to 1 when DXP1 and DXN1 are either shorted or open circuit.
0	Reserved	0	_

### **ADC Noise Filtering**

The integrating ADC has good noise rejection for lowfrequency signals, such as power-supply hum. In environments with significant high-frequency EMI, connect an external 2200pF capacitor between DXP\_ and DXN\_. Larger capacitor values can be used for added filtering, but do not exceed 3300pF because it can introduce errors due to the rise time of the switched current source. High-frequency noise reduction is needed for high-accuracy remote measurements. Noise can be reduced with careful PC board layout as discussed in the *PC Board Layout* section.

# Table 10. Remote-Sensors TransistorManufacturers

MANUFACTURER	MODEL NO.	
Central Semiconductor (USA)	CMPT3904	
Rohm Semiconductor (USA)	SST3904	
Samsung (Korea)	KST3904-TF	
Siemens (Germany)	SMBT3904	
Zetex (England)	FMMT3904CT-ND	

*Note:* Discrete transistors must be diode connected (base shorted to collector).

**Slave Address** Table 11 shows the MAX6699 slave address.

PART	SMBus SLAVE ID	PIN-PACKAGE						
MAX6699EE34	0011 010	16 QSOP						
MAX6699EE38	0011 100	16 QSOP						
MAX6699EE99	1001 100	16 QSOP						
MAX6699EE9C	1001 110	16 QSOP						
MAX6699UE34	0011 010	16 TSSOP						
MAX6699UE38	0011 100	16 TSSOP						
MAX6699UE99	1001 100	16 TSSOP						
MAX6699UE9C	1001 110	16 TSSOP						

### **Table 11. Slave Address**

### PC Board Layout

## Follow these guidelines to reduce the measurement error when measuring remote temperature:

 Place the MAX6699 as close as is practical to the remote diode. In noisy environments, such as a computer motherboard, this distance can be 4in to 8in (typ). This length can be increased if the worst

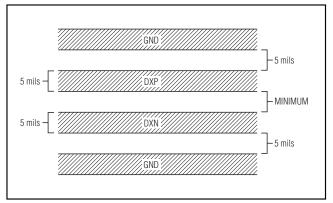


Figure 5. Recommended Minimum DXP-DXN PC Board Traces.

noise sources are avoided. Noise sources include CRTs, clock generators, memory buses, and PCI buses.

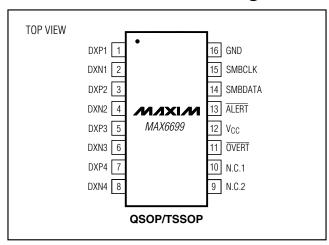
- Do not route the DXP-DXN lines next to the deflection coils of a CRT. Also, do not route the traces across fast digital signals, which can easily introduce +30°C error, even with good filtering.
- 3) Route the DXP and DXN traces in parallel and in close proximity to each other. Each parallel pair of traces should go to a remote diode. Route these traces away from any higher voltage traces, such as +12VDC. Leakage currents from PC board contamination must be dealt with carefully since a 20MΩ leakage path from DXP to ground causes about +1°C error. If high-voltage traces are unavoidable, connect guard traces to GND on either side of the DXP-DXN traces (Figure 5).
- 4) Route through as few vias and crossunders as possible to minimize copper/solder thermocouple effects.
- 5) Use wide traces when practical.
- 6) When the power supply is noisy, add a resistor (up to  $47\Omega$ ) in series with V<sub>CC</sub>.

### **Twisted-Pair and Shielded Cables**

Use a twisted-pair cable to connect the remote sensor for remote-sensor distances longer than 8in or in very noisy environments. Twisted-pair cable lengths can be between 6ft and 12ft before noise introduces excessive errors. For longer distances, the best solution is a shielded twisted pair like that used for audio microphones. For example, Belden #8451 works well for distances up to 100ft in a noisy environment. At the device, connect the twisted pair to DXP and DXN and the shield to GND. Leave the shield unconnected at the



remote sensor. For very long cable runs, the cable's parasitic capacitance often provides noise filtering, so the 2200pF capacitor can often be removed or reduced in value. Cable resistance also affects remote-sensor accuracy. For every 1 $\Omega$  of series resistance, the error is approximately +1/2°C.



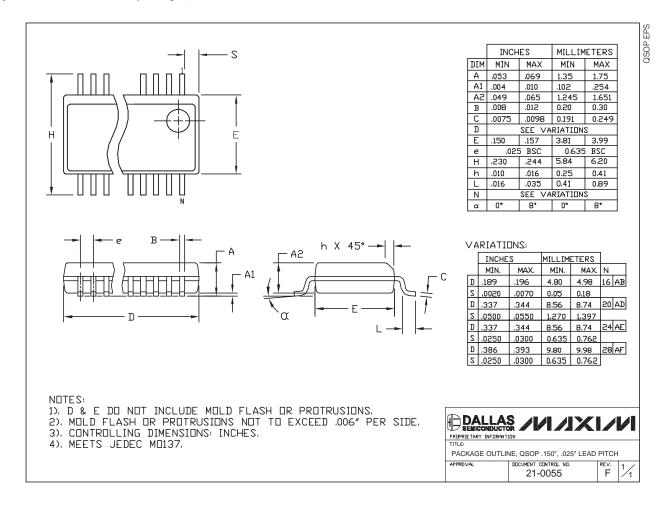
### **Pin Configuration**

**Chip Information** 

PROCESS: BiCMOS

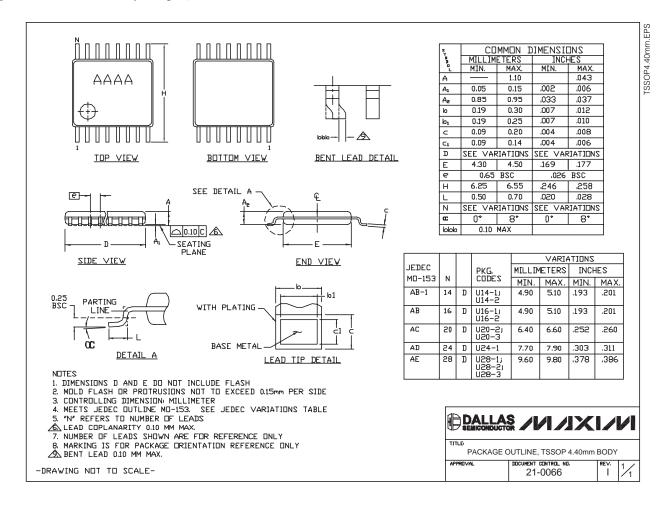
### **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <u>www.maxim-ic.com/packages</u>.)



### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



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